

Important Safety Advice

Depending on the mode of operation, these devices emit highly concentrated visible light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions found in IEC 60825-1 (Safety of laser products).

Do not expose the eyes or skin to any laser light directly and/or through optical lenses. When handling the laser diodes wear appropriate safety glasses.

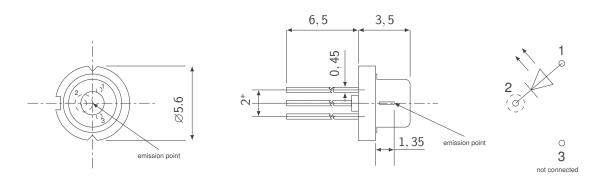
Features

- 95 mW optical power
- 5.6 mm TO package
- Singlemode

Applications

- Industry
- Sensor
- Illumination
- Consumer

Dimensions



all dimensions in mm. Tolerance $\pm 0,\, 1$ except given ones * at the bottom of the LED

Material data

DESCRIPTION	Material	FINISH
Laser Diode chip	AllnGaP	
Stem	Fe	Au plated
Cap	45 alloy	Ni, Pd plated
Lead Pins	Kovar	Au plated
Window		

LA LS56HRSM1





Electro-optical characteristics ($T_A = 25^{\circ}\text{C}$)²

PARAMETER	SYMBOL	Condition	MIN.	Typ.1	Max.	Unit
Threshold Current	I_{th}			40	90	mA
Differential efficiency	η_d		0,5	1,1		W/A
Forward voltage	V_F	$\Phi_e=$ 95 mW		2,4	3,5	V
Forward current	I_F	$\Phi_e=$ 95 mW		122	250	mA
Peak wavelength	λ_{peak}	$\Phi_e=$ 95 mW	652	660	670	nm
Tilt Angle parallel	$\Delta\Theta_{\parallel}$	$\Phi_e=$ 95 mW	-3		3	0
Tilt Angle perpendicular	$\Delta\Theta_{\perp}^{''}$	$\Phi_e=$ 95 mW	-3		3	0
Ripple Note	R		-20		20	%

Note: Ripple is defined as the maximum deviation of the far field pattern from its approximate curve divided by the peak of the approixmate curve.

Maximum ratings ($T_A=25^{\circ}$ C)

PARAMETER	SYMBOL	Condition	Мінімим	MAXIMUM	Unit
Optical Power	$\Phi_{e,max}$	+ 20 D 40 ⁰⁷		100	mW mW
Optical Pulse Power Operating Temperature	$\Phi_{ep,max}$ T_{op}	$t_p = 30ns, D = 40\%$	-10	250 70	° C
Storage Temperature Soldering Temperature $Note$	T_{st} T_{sold}		-40	85 320	° C
Reverse Voltage	V_R		2	320	V

Thermal characteristics

PARAMETER	SYMBOL	Value	Unit
Soldering temperature	T_{sold}	320	°C

Note: Soldering temperature refers to an iron tip temperature (max 50W power) during the solder process. Soldering positions should be 2mm away from the bottom edge of the case. The immersion time must be less than 2s.

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Important Usage and Application Information

Lead free product - RoHS compliant.

All products, product specifications and data to improve reliability, function, design or otherwise are subject to change without notice. The information describes the type of component and shall not be considered as assured characteristics.

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.

These laser diodes are designed as consumer goods in production and quality, especially in the application areas of computers, measuring equipment, tooling machines, audio visual equipment and home applicances. Please do not use this product for equipment, which needs extremely high reliability and safety in function and precision. Operating the laser diode above the maximum rating even for very short periods of time can damage the laser diode or reduce its lifetime. The laser diode must be operated with a suitable power supply with minimized electrical noise. When using this product, please stay within the maximum ratings, pay attention to the other instructions, conditions and precautions described in this datasheet. We will assume no responsibility for any damages resulting from improper use of this product.

Handling and Storage Conditions

The laser diode is very sensitive to electrostatic discharge (ESD). Proper precautions must be taken. Furthermore the package is a not hermetic package. Please be careful by using this product in humid atmosphere or atmosphere containing caustic or corrosive gases as this may cause the product to fail. When the product is soldered, please do not apply pyhsical stress to the lead pins. Avoid the heating of the complete package by preheating or reflow. Please only heat the lead section for a short time. When the leads are formed or cutted, please do not apply physical stress.

Please finish soldering within 7 days or keep the products in a sealed box to avoid silver oxidization.

Packing

Laser diodes are arranged in trays. A cover is put on the top of the tray. For shipment the trays are arranged to stacks and placed into an ESD bag and packaging box. Please use the recycling operators familiar to you. If required you can ask for our help. Please get in touch with your nearest sales office. By agreement we will take packing material back, if sorted. Transport costs of any kind must be paid by customers. For packing material that is returned to us unsorted or which we are not obliged to accept, any costs incurred will be invoiced to you.

Returns and Complaints

For complaints and returns of material a RMA-number is necessary. Samples for analysis purposes can be send to us without credit.

Shipping Conditions

If not otherwise arranged, the "General Terms of Business of Light Avenue GmbH" apply for any shipment. If this document is not familiar to you, please request it at our nearest sales office.

LA LS56HRSM1

Hyper Red Laser Diode (660 nm), Single Mode



Disclaimer

Attention please! Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components³ may only be used in life-support devices⁴ or systems with the express written approval by us.

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¹Due to the special conditions of the manufacturing processes of lasers, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

 $^{^2}$ Light Measurements are done with an accuracy of $\pm 15\%$. Voltage and wavelength are measured with an accuracy of ± 0.1 V and ± 1 nm. Correlation to customer's equipment and products is required.

³A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

⁴Life support devices or systems are intended(a) to be implanted in the human body,or(b) to support and/or maintain and sustain human life.If they fail, it is reasonable to assume that the health and the life of the user may be endangered..